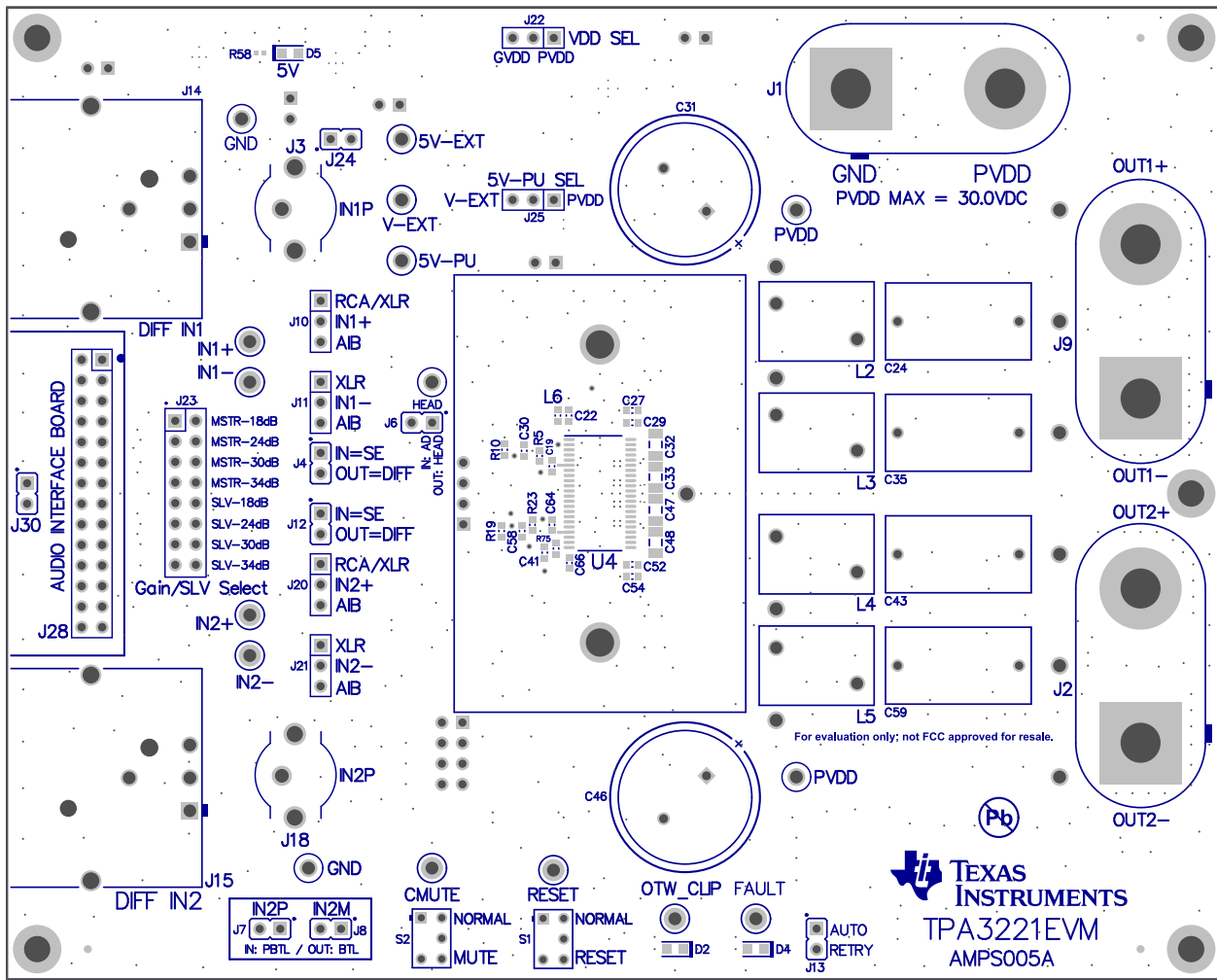


Top Overlay
 Top Layer
 Top Layer

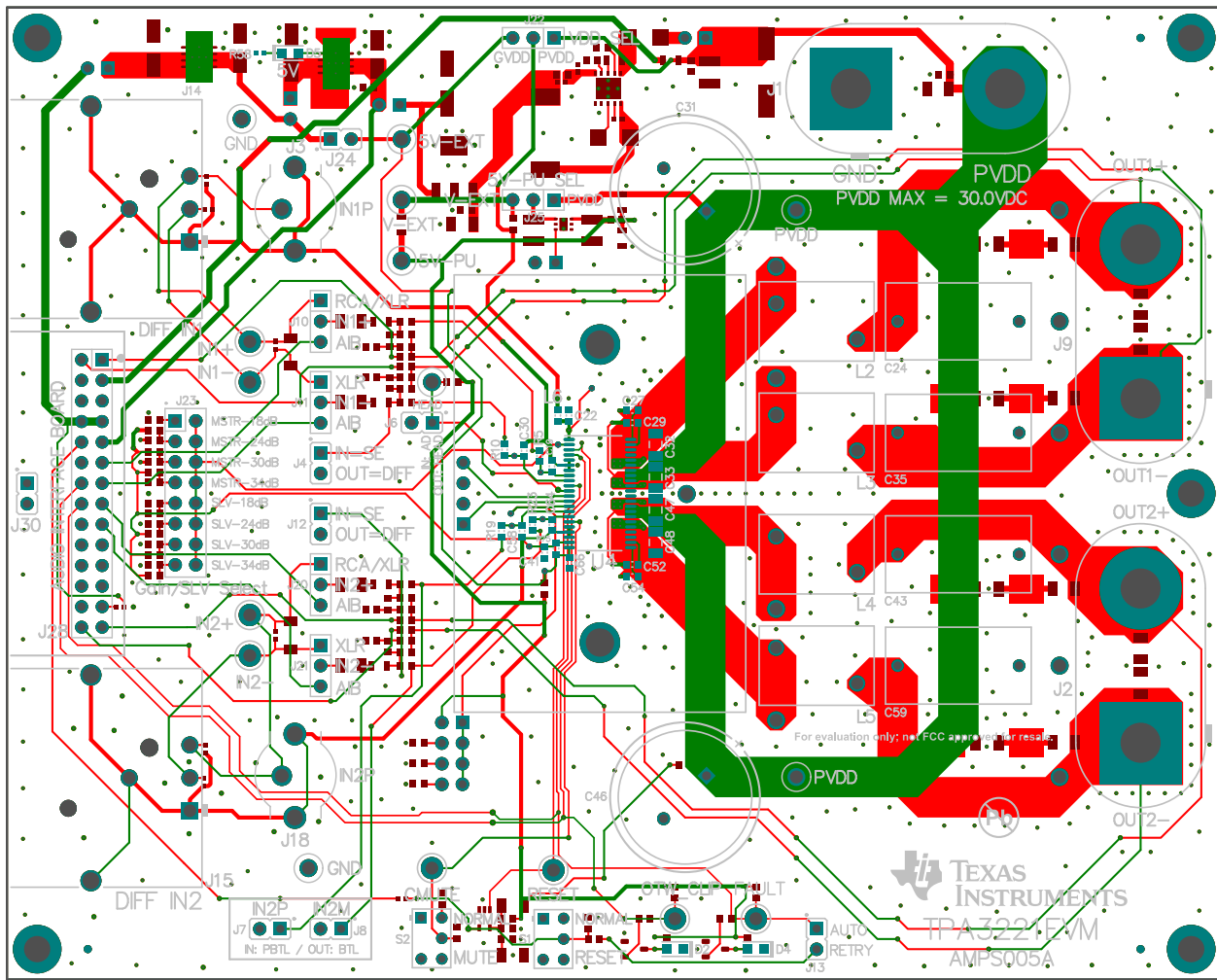
TEXAS
 INSTRUMENTS
 TPA3221EVM
 AMP005A



Top Overlay

For evaluation only; not FCC approved for resale.

TEXAS INSTRUMENTS
 TPA3221EVM
 AMPS005A

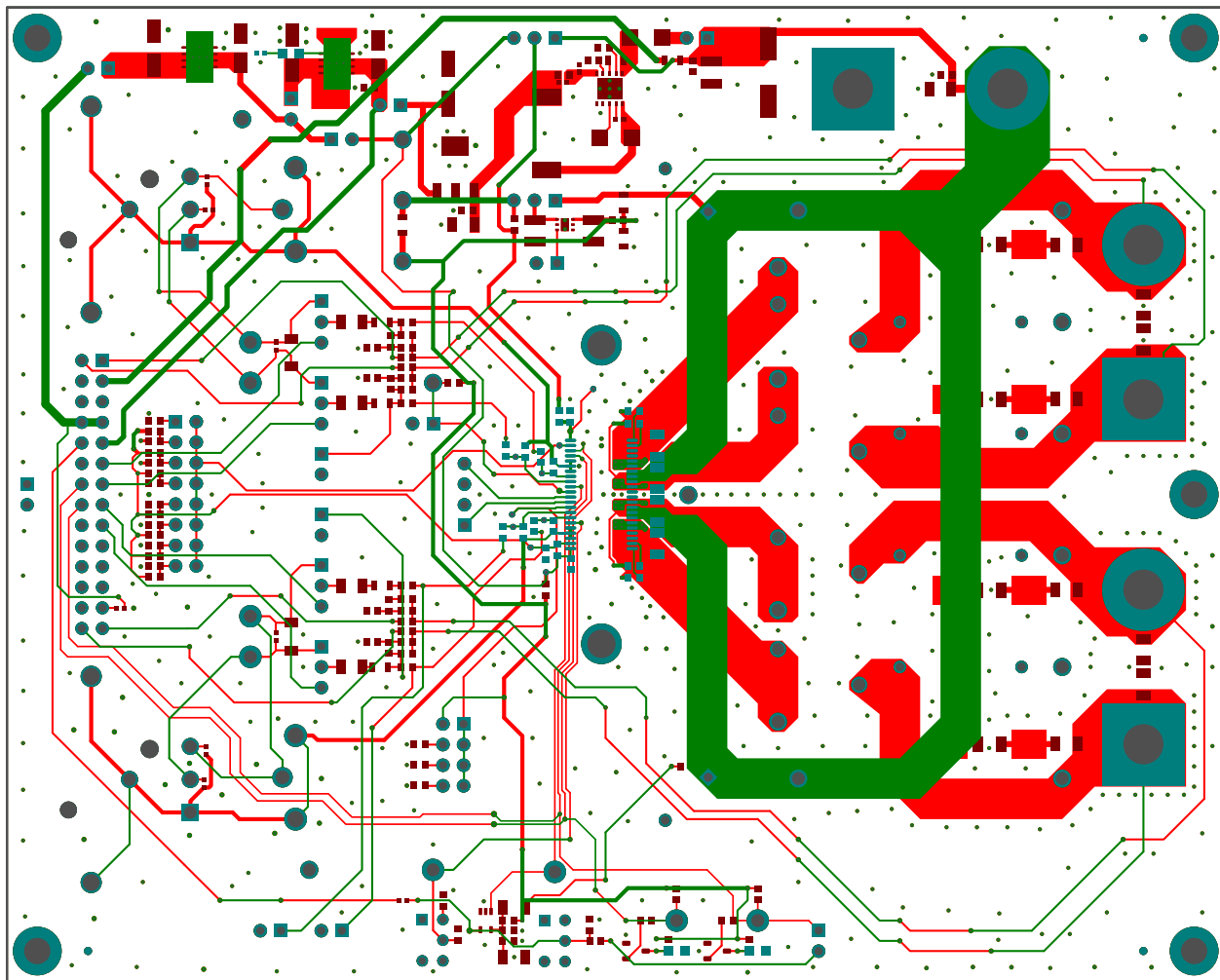


Top Overlay

Top Layer

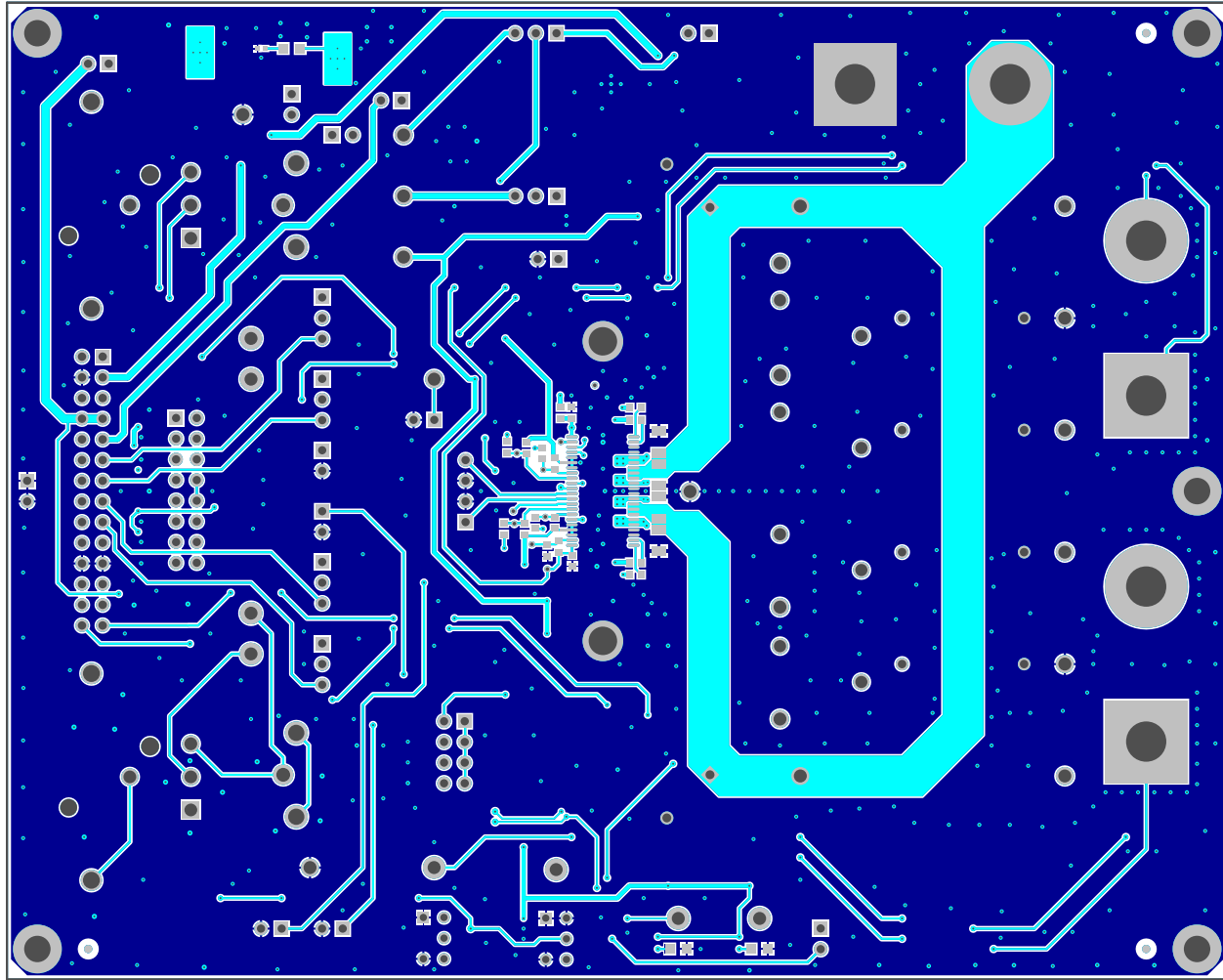
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TEXAS
INSTRUMENTS
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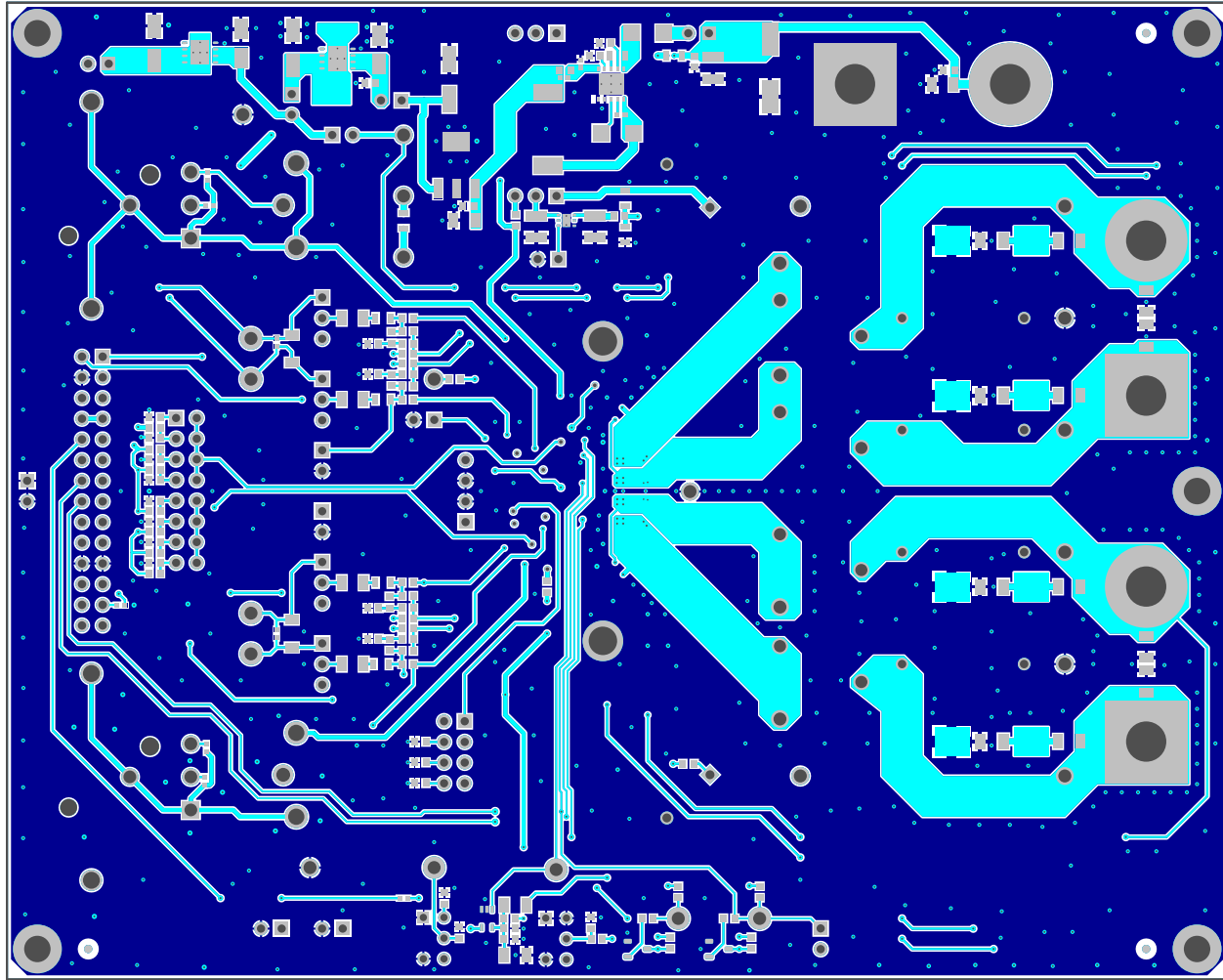


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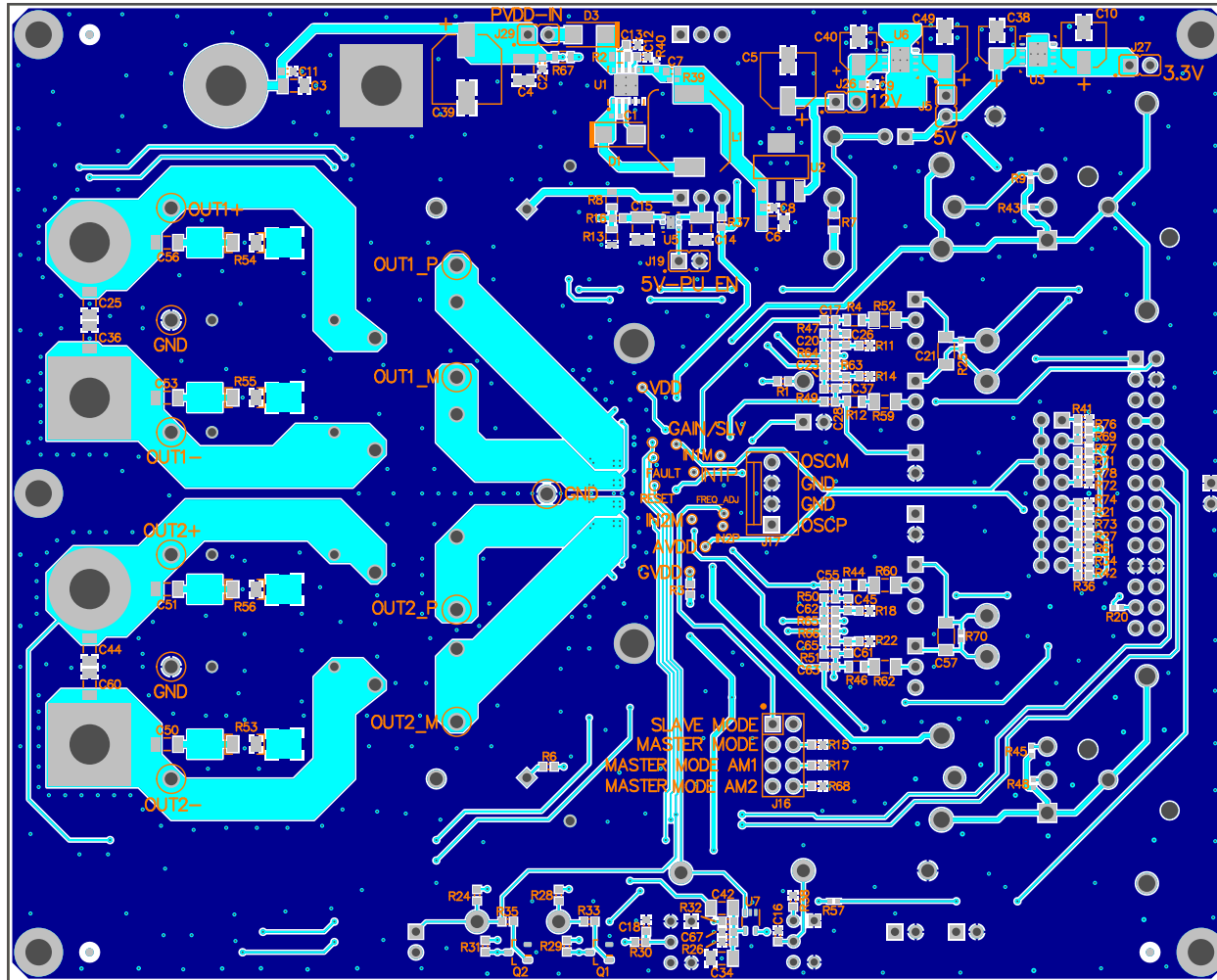
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Top Layer
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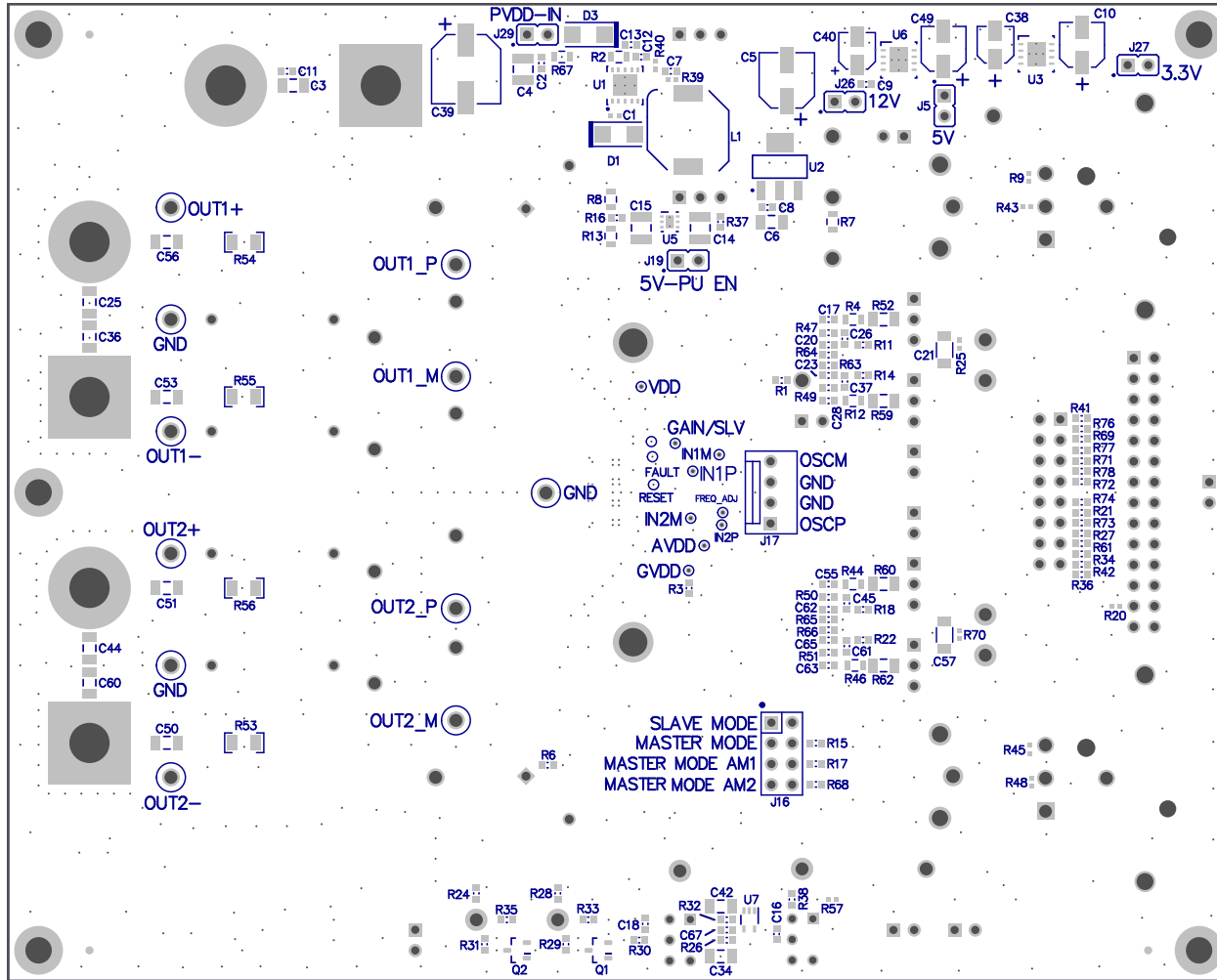


Bottom Layer
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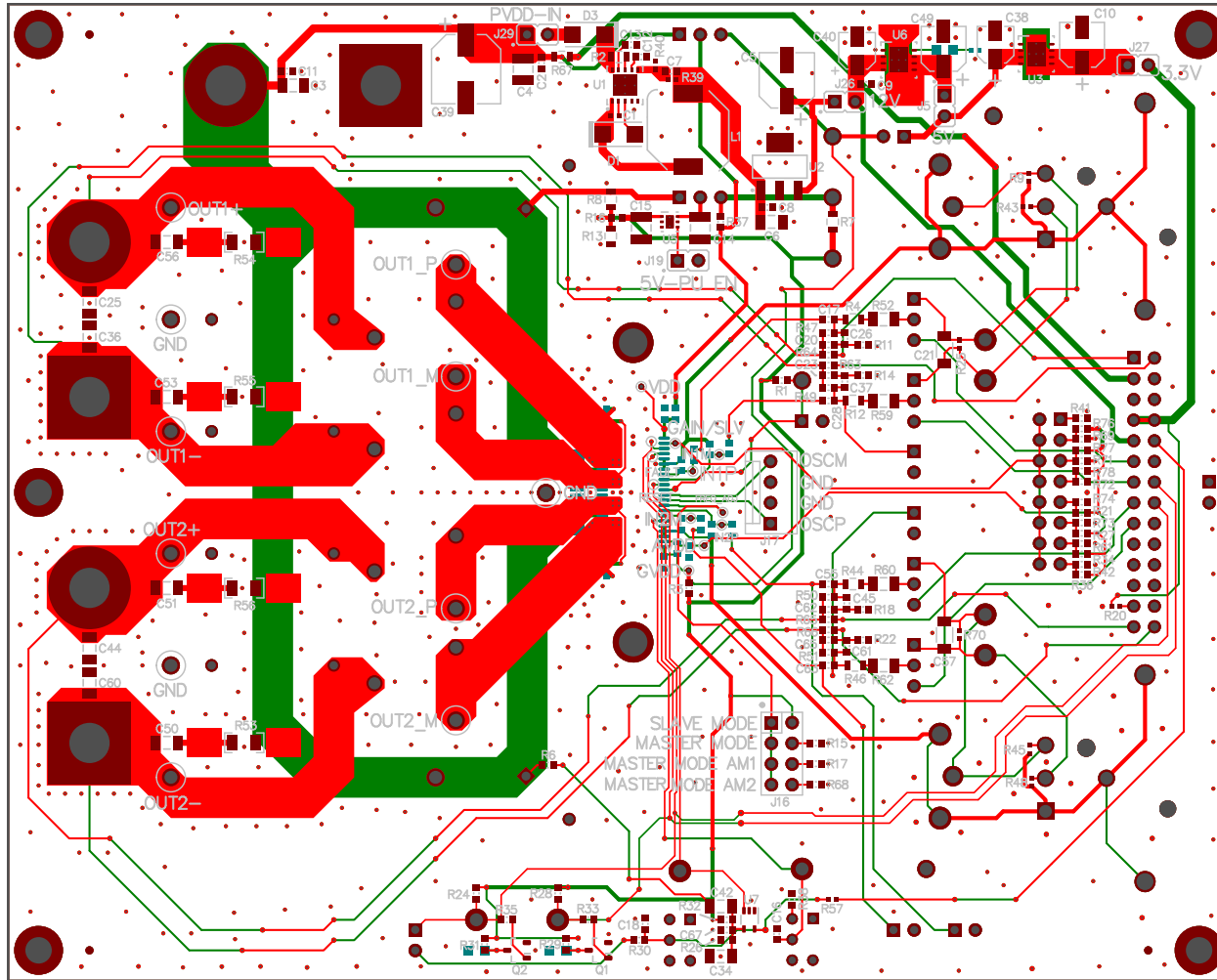


Bottom Overlay

Bottom Layer
Bottom Layer



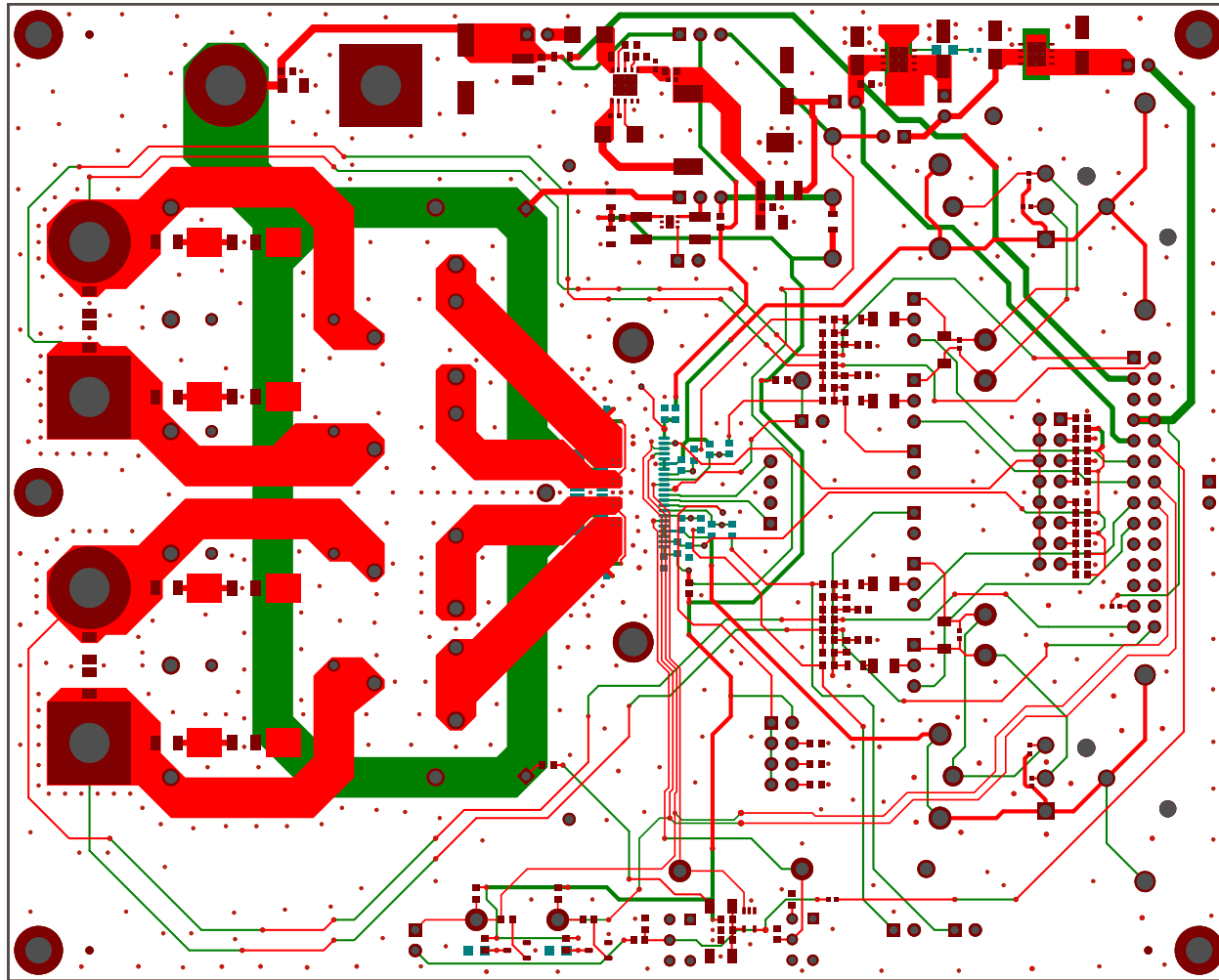
Bottom Overlay



Bottom Overlay

Top Layer

Bottom Layer



Top Layer

Bottom Layer

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